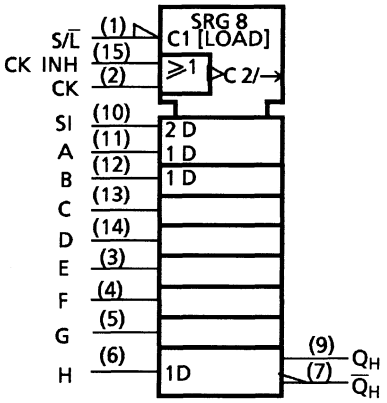
IEC Logic Symbol



Truth Table

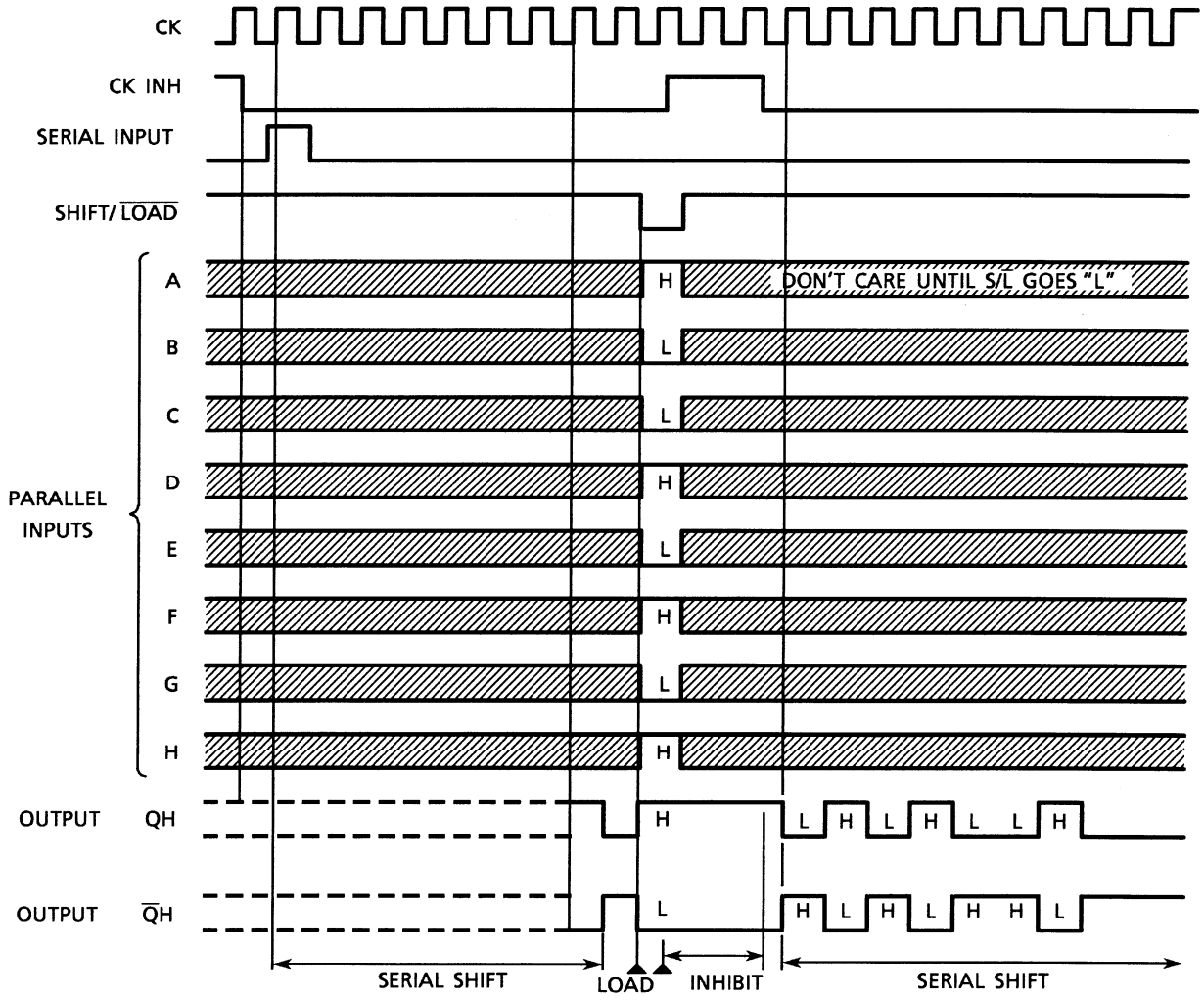
Inputs					Internal Outputs		Outputs	
SHIFT/$\overline{\text{LOAD}}$	CLOCK INH	CLOCK	SERIAL IN	PARALLEL A·····H	QA	QB	QH	$\overline{\text{QH}}$
L	X	X	X	a·····h	a	b	h	$\overline{\text{h}}$
H	L	↑	H	X	H	QAn	QGn	$\overline{\text{QGn}}$
H	L	↑	L	X	L	QAn	QGn	$\overline{\text{QGn}}$
H	↑	L	H	X	H	QAn	QGn	$\overline{\text{QGn}}$
H	↑	L	L	X	L	QAn	QGn	$\overline{\text{QGn}}$
H	X	H	X	X	No Change			
H	H	X	X	X	No Change			

X: Don't care

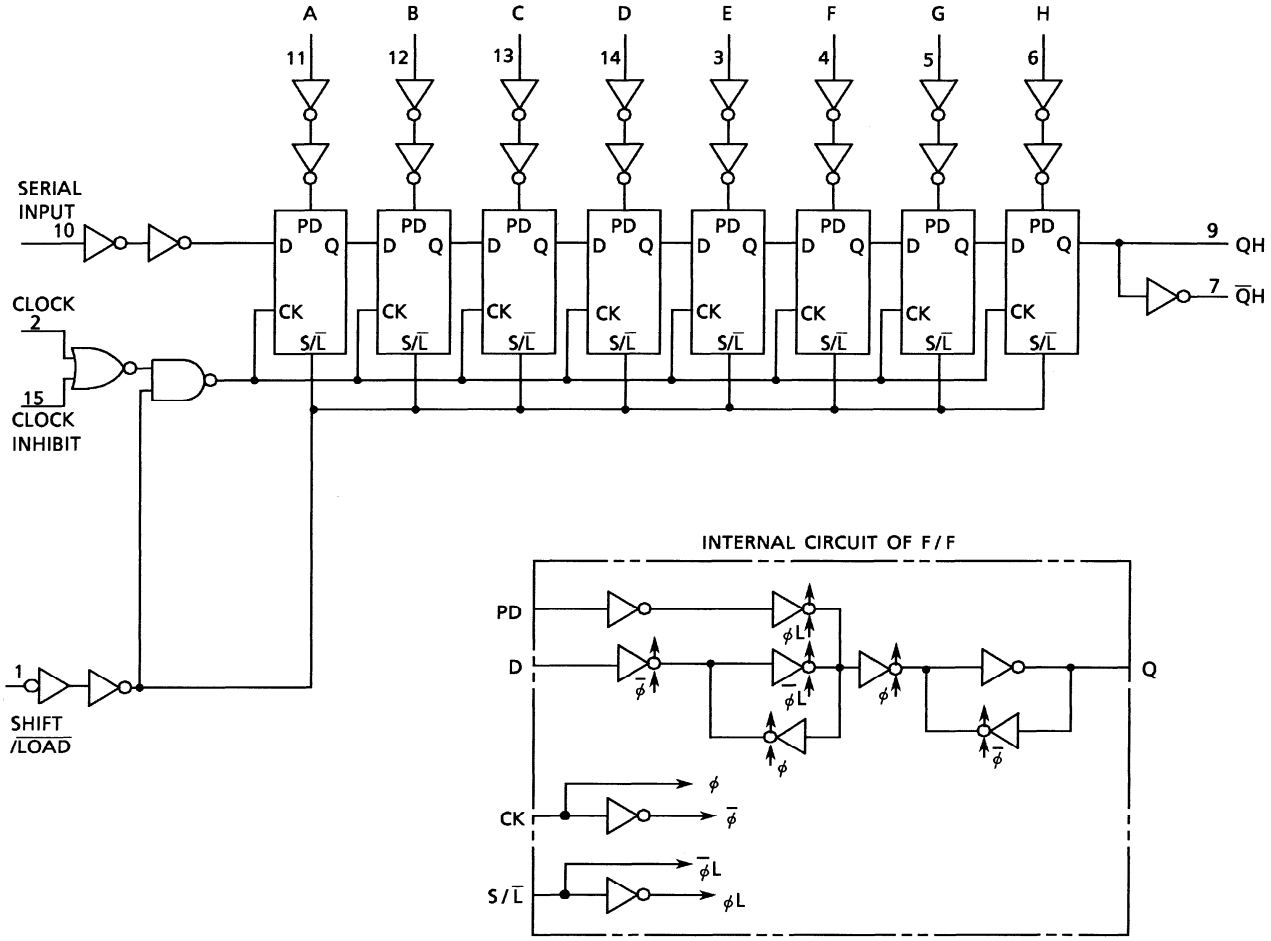
a·····h: The level of steady state input voltage at inputs A through H respectively

QAn~QGn: The level of QA~QG, respectively, before the most recent positive transition of the CK.

Timing Chart



System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	−0.5 to 7	V
DC input voltage	V_{IN}	−0.5 to V_{CC} + 0.5	V
DC output voltage	V_{OUT}	−0.5 to V_{CC} + 0.5	V
Input diode current	I_{IK}	±20	mA
Output diode current	I_{OK}	±20	mA
DC output current	I_{OUT}	±25	mA
DC V_{CC}/ground current	I_{CC}	±50	mA
Power dissipation	P_D	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T_{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = −40 to 65°C. From Ta = 65 to 85°C a derating factor of −10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2 to 6	V
Input voltage	V_{IN}	0 to V_{CC}	V
Output voltage	V_{OUT}	0 to V_{CC}	V
Operating temperature	T_{opr}	−40 to 85	°C
Input rise and fall time	t_r, t_f	0 to 1000 (V_{CC} = 2.0 V) 0 to 500 (V_{CC} = 4.5 V) 0 to 400 (V_{CC} = 6.0 V)	ns

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C				Ta = −40 to 85°C		Unit
				V_{CC} (V)	Min	Typ.	Max	Min	Max	
High-level input voltage	V_{IH}	—		2.0	1.50	—	—	1.50	—	V
				4.5	3.15	—	—	3.15	—	
				6.0	4.20	—	—	4.20	—	
Low-level input voltage	V_{IL}	—		2.0	—	—	0.50	—	0.50	V
				4.5	—	—	1.35	—	1.35	
				6.0	—	—	1.80	—	1.80	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = −20 μA	2.0	1.9	2.0	—	1.9	—	V
				4.5	4.4	4.5	—	4.4	—	
				6.0	5.9	6.0	—	5.9	—	
			I_{OH} = −4 mA	4.5	4.18	4.31	—	4.13	—	
			I_{OH} = −5.2 mA	6.0	5.68	5.80	—	5.63	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 20 μA	2.0	—	0.0	0.1	—	0.1	V
				4.5	—	0.0	0.1	—	0.1	
				6.0	—	0.0	0.1	—	0.1	
			I_{OL} = 4 mA	4.5	—	0.17	0.26	—	0.33	
			I_{OL} = 5.2 mA	6.0	—	0.18	0.26	—	0.33	
Input leakage current	I_{IN}	V_{IN} = V_{CC} or GND		6.0	—	—	±0.1	—	±1.0	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND		6.0	—	—	4.0	—	40.0	μA

Timing Requirements (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = −40 to 85°C	Unit
			V_{CC} (V)	Typ.	Limit	Limit	
Minimum pulse width (CK, CK INH)	$t_{W(H)}$ $t_{W(L)}$	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum pulse width ($S/\overline{L}$)	$t_{W(L)}$	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum set-up time (PI- $S/\overline{L}$)	t_s	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum set-up time (SI-CK, CK INH)	t_s	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum set-up time ($S/\overline{L}$ -CK, CK INH)	t_s	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Minimum hold time (PI- $S/\overline{L}$)	t_h	—	2.0	—	0	0	ns
			4.5	—	0	0	
			6.0	—	0	0	
Minimum hold time (SI-CK, CK INH)	t_h	—	2.0	—	0	0	ns
			4.5	—	0	0	
			6.0	—	0	0	
Minimum hold time ($S/\overline{L}$ -CK, CK INH)	t_h	—	2.0	—	0	0	ns
			4.5	—	0	0	
			6.0	—	0	0	
Minimum removal time (CK INH-CK) (CK-CK INH)	t_{rem}	—	2.0	—	75	95	ns
			4.5	—	15	19	
			6.0	—	13	16	
Clock frequency	f	—	2.0	—	7	6	MHz
			4.5	—	30	24	
			6.0	—	41	28	

AC Characteristics ($C_L = 15$ pF, $V_{CC} = 5$ V, Ta = 25°C, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Output transition time	t_{TLH} t_{THL}	—	—	4	8	ns
Propagation delay time (CK, CK INH-QH, $\overline{Q}$H)	t_{pLH} t_{pHL}	—	—	15	25	ns
Propagation delay time ($S/\overline{L}$ -QH, $\overline{Q}$H)	t_{pLH} t_{pHL}	—	—	15	25	ns
Propagation delay time (H-QH, $\overline{Q}$H)	t_{pLH} t_{pHL}	—	—	14	26	ns
Maximum clock frequency	f_{max}	—	35	56	—	MHz

AC Characteristics (C_L = 50 pF, input: $t_r = t_f$ = 6 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
			V_{CC} (V)	Min	Typ.	Max	Min	Max	
Output transition time	t_{TLH} t_{THL}	—	2.0	—	25	75	—	95	ns
			4.5	—	8	15	—	19	
			6.0	—	7	13	—	16	
Propagation delay time (CK, CK INH-QH, $\overline{Q}$H)	t_{pLH} t_{pHL}	—	2.0	—	55	150	—	190	ns
			4.5	—	18	30	—	38	
			6.0	—	15	26	—	33	
Propagation delay time (S/$\overline{L}$ -QH, $\overline{Q}$H)	t_{pLH} t_{pHL}	—	2.0	—	60	165	—	205	ns
			4.5	—	19	33	—	41	
			6.0	—	16	28	—	35	
Propagation delay time (H-QH, $\overline{Q}$H)	t_{pHL}	—	2.0	—	52	135	—	170	ns
			4.5	—	17	27	—	34	
			6.0	—	14	23	—	29	
Maximum clock frequency	f_{max}	—	2.0	7	14	—	6	—	MHz
			4.5	30	46	—	24	—	
			6.0	41	65	—	28	—	
Input capacitance	C_{IN}	—		—	5	10	—	10	pF
Power dissipation capacitance	C_{PD} (Note)	—		—	55	—	—	—	pF

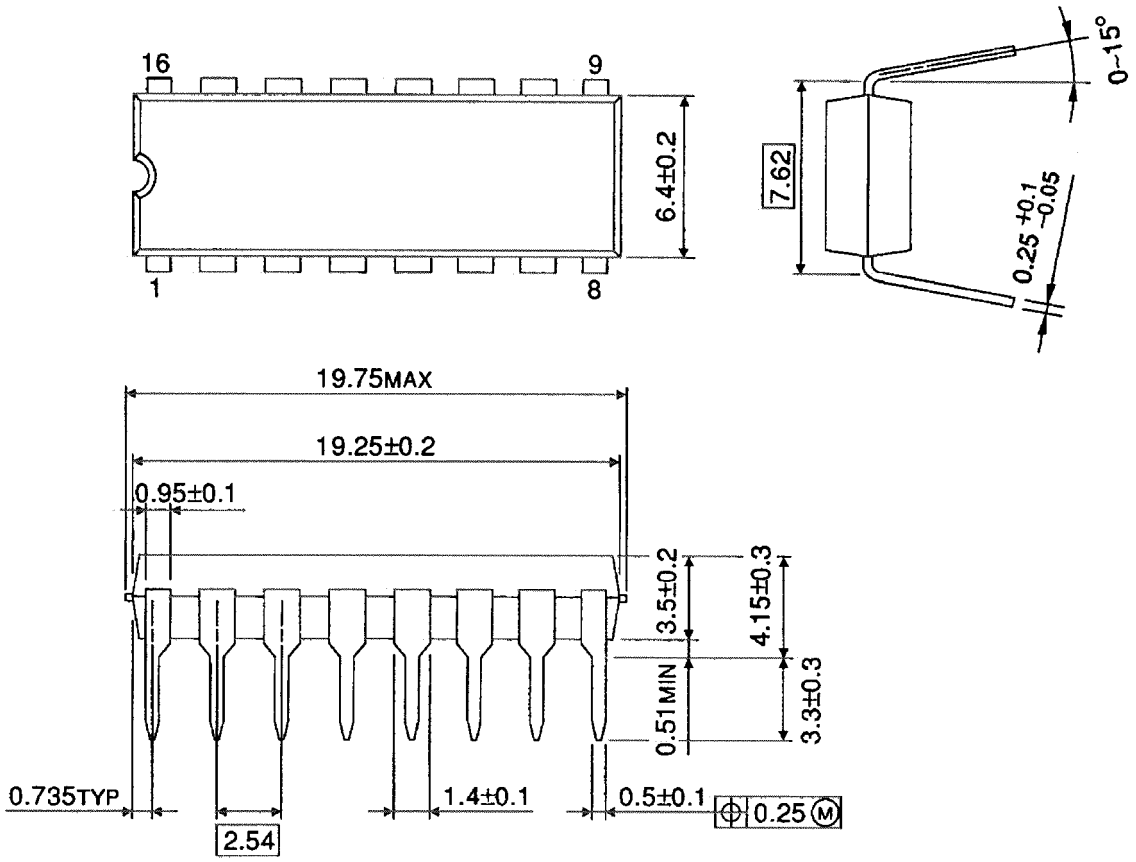
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}\ (opr) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

Package Dimensions

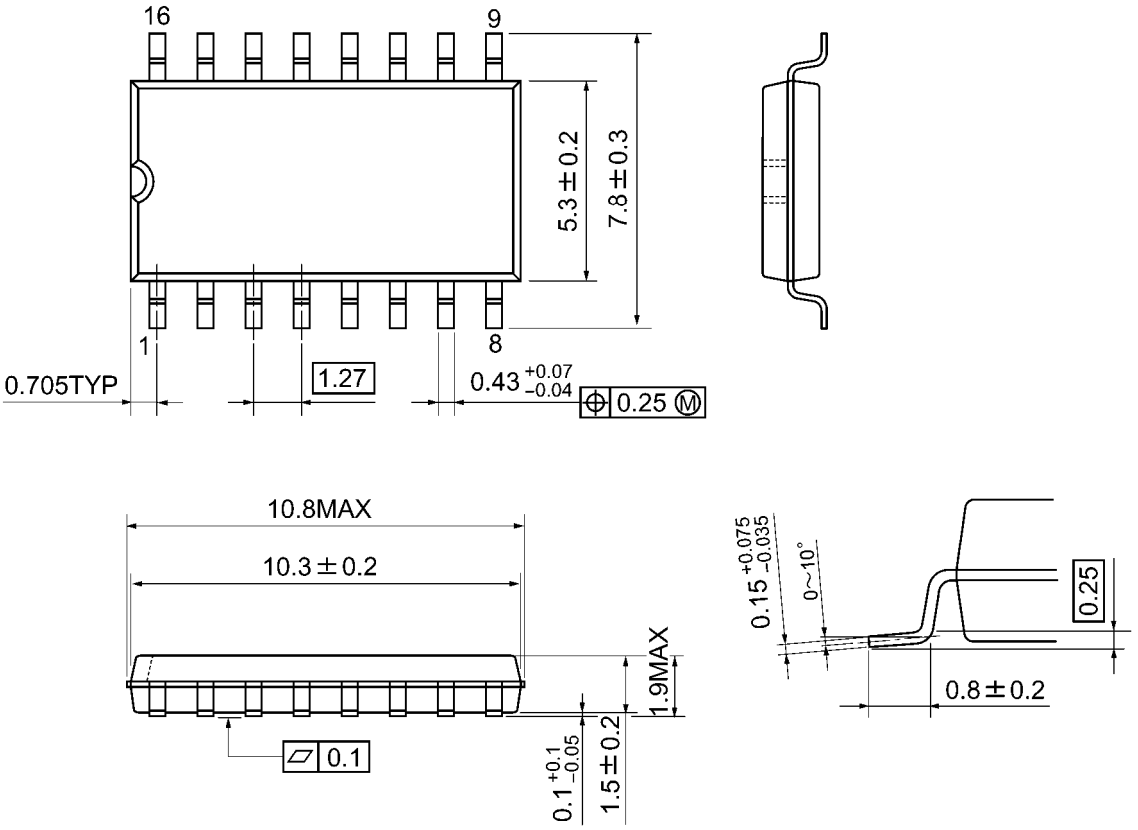
DIP16-P-300-2.54A Unit : mm



Weight: 1.00 g (typ.)

Package Dimensions

SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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